## **EMEME** Micro-Measurements



## **Strain Gage Adhesive**



# OTHER ACCESSORIES USED IN AN M-BOND AE-15 INSTALLATION:

- CSM Degreaser or GC-6 Isopropyl Alcohol
- Silicon-Carbide Paper
- M-Prep Conditioner A
- M-Prep Neutralizer 5A
- GSP-1 Gauze Sponges
- CSP-1 Cotton Applicators
- PCT-2M Gage Installation Tape
- HSC Spring Clamp
- GT-14 Pressure Pads and Backup Plates



RoHS

#### **DESCRIPTION**

Two-component, 100%-solids epoxy system for general-purpose stress analysis. Transparent, medium viscosity. Cure time as low as six hours at +125°F [+50°C]. Recommended for more critical applications, including transducers. It has a longer pot life than M-Bond AE-10 which allows more time for multiple gage installations.

Elevated-temperature postcure is recommended for maximum stability, and/or tests above room temperature. Highly resistant to moisture and most chemicals, particularly when postcured. For maximum elongation, bonding surface must be roughened. Cryogenic applications require very thin gluelines.

#### **CHARACTERISTICS**

#### **Operating Temperature Range:**

Long Term: -452° to +200°F [-269° to +95°C].

Transducers: to +175°F [+80°C].

#### **Elongation Capabilities:**

2% at -320°F [-195°C]; 10% to 15% at +75°F [+24°C]; 15% at +200°F [+95°C].

#### Shelf Life:

Minimum 12 months at +75°F [+24°C]; or 18 months at +40°F [+5°C]. If crystals form in resin jar, heat to +120°F [+50°C] for 30 minutes. Cool before mixing.

#### Pot Life:

1-1/2 hours at +75°F [+24°C].

#### **Clamping Pressure:**

5 to 20psi [35 to 140kN/m<sup>2</sup>].

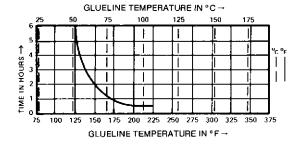
#### **Cure Requirements:**

Recommended PostCure: 2 hours at 25°F [15°C] above

maximum operating temperature.

#### **Optimum Performance Transducer Postcure:**

1 hour at +200°F [+95°C].



### **PACKAGING OPTIONS**

#### Kit:

6 mixing jars [10g ea] Resin 1 bottle [15ml] Curing Agent 15 6 calibrated pipettes

6 stirring rods

#### Bulk: 200g Resin

25g Curing Agent 15 3 calibrated pipettes

References: Instruction Bulletin B-137, "Strain Gage Applications with M-Bond AE-10, AE-15, and GA-2 Adhesive Systems", included

in each kit.

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